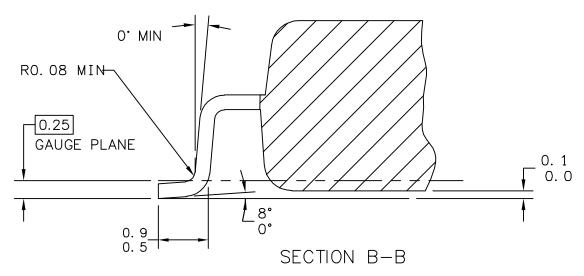
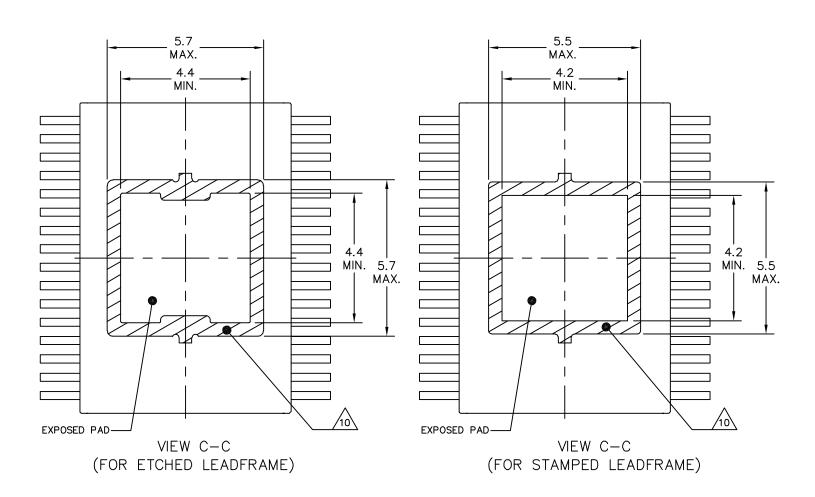


NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OU	TLINE	PRINT VERSION N	OT TO SCALE	
TITLE:	DOCUMEN	NT NO: 98ASA10556D	REV: G		
32LD SOIC W/B, 0.65 PITCH 4.7 X 4.7 EXPOSED PAD			STANDARD: NON-JEDEC		
+./ X 4./ LXI OSLL) AD	S0T1746	5–3	17 MAR 2017	







NXP SEMICONDUCTORS N. V. ALL RIGHTS RESERVED	MECHANICAL OU	TLINE	PRINT VERSION N	OT TO SCALE
TITLE: 32LD SOIC W/B, 0.65 PITCH 4.7 X 4.7 EXPOSED PAD		DOCUMEN	NT NO: 98ASA10556D	REV: G
		STANDARD: NON-JEDEC		
7.7 X 7.7 EXTOSEL	IAU	S0T1746	5–3	17 MAR 2017



NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. DATUMS B AND C TO BE DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.



THIS DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS. MOLD FLASH, PROTRUSION OR GATE BURRS SHALL NOT EXCEED 0.15 MM PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.



THIS DIMENSION DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.25 MM PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.



THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.4 mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD SHALL NOT LESS THAN 0.07 mm.



EXACT SHAPE OF EACH CORNER IS OPTIONAL.



THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10~mm AND 0.3~mm FROM THE LEAD TIP.



THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. THIS DIMENSION IS DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTER-LEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.



HATCHED AREA TO BE KEEP-OUT ZONE FOR PCB ROUTING.

NXP SEMICONDUCTORS N.V. ALL RIGHTS RESERVED	MECHANICAL OU	TLINE	PRINT VERSION N	OT TO SCALE
TITLE:		DOCUMEN	NT NO: 98ASA10556D	REV: G
32LD SOIC W/B, 0.65 4.7 X 4.7 FXPOSED		STANDAF	RD: NON-JEDEC	
4.7 A 4.7 EXI OSED		S0T1746	5–3	17 MAR 2017